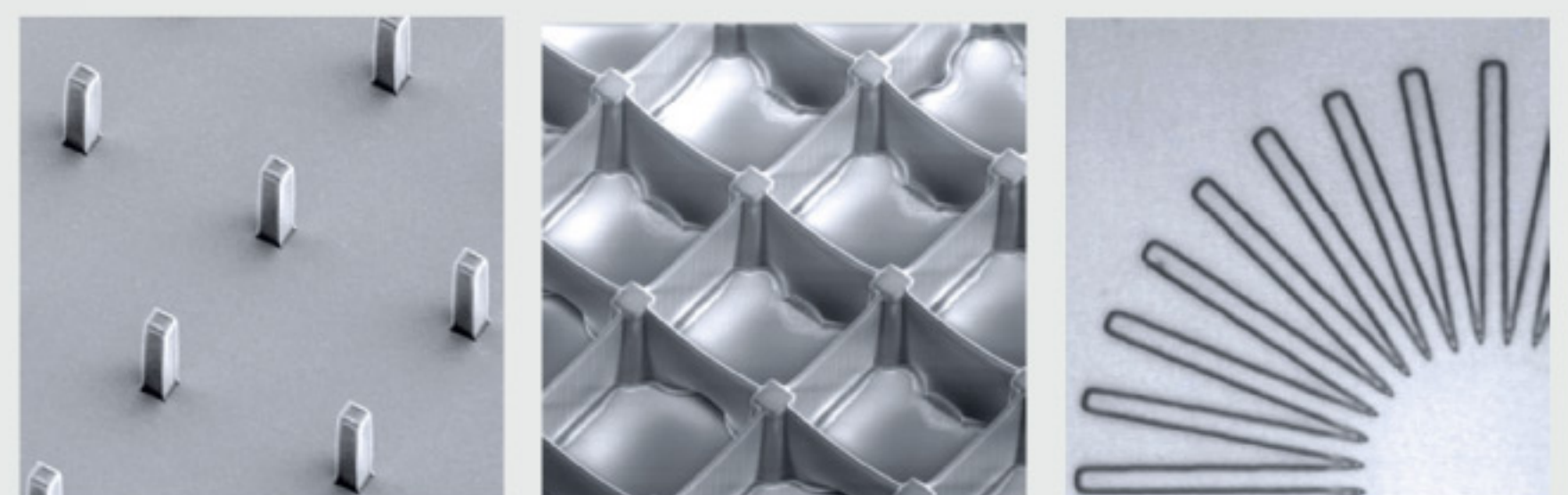


μMLA

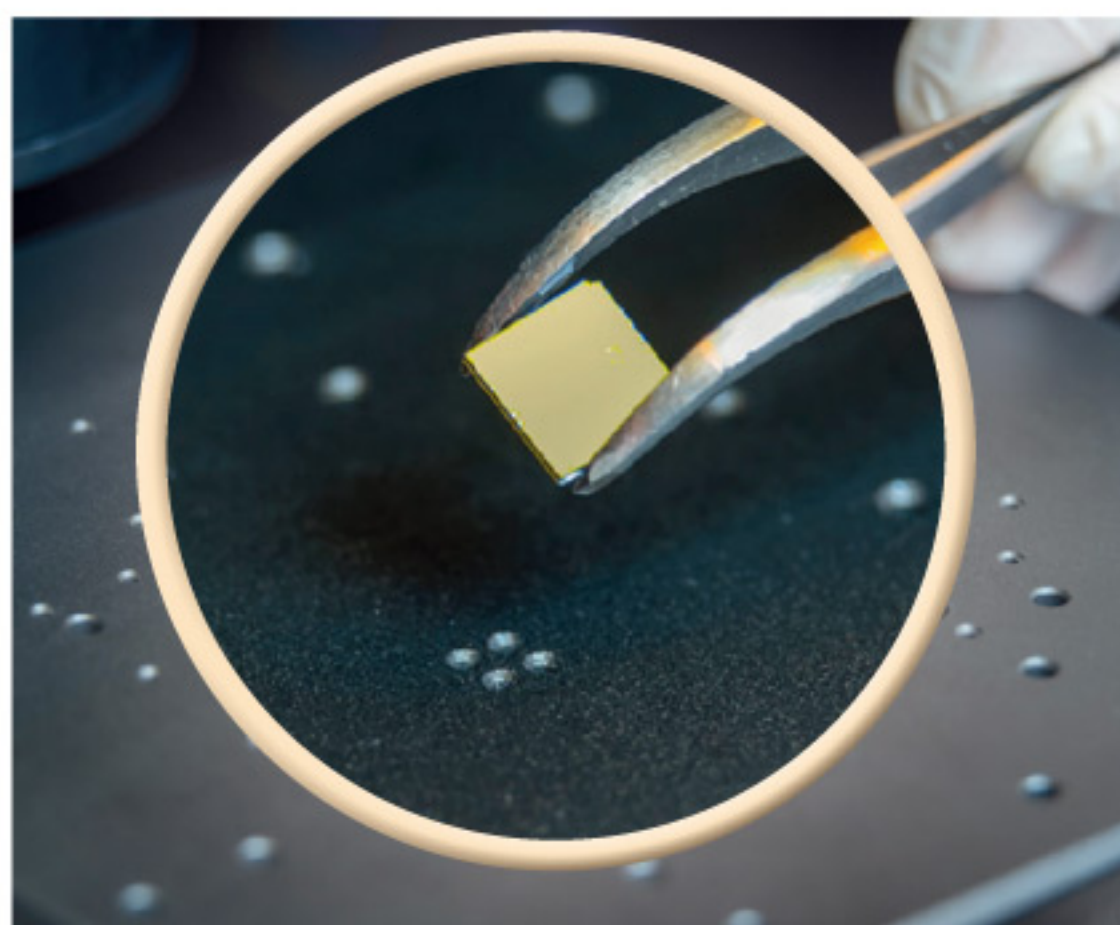
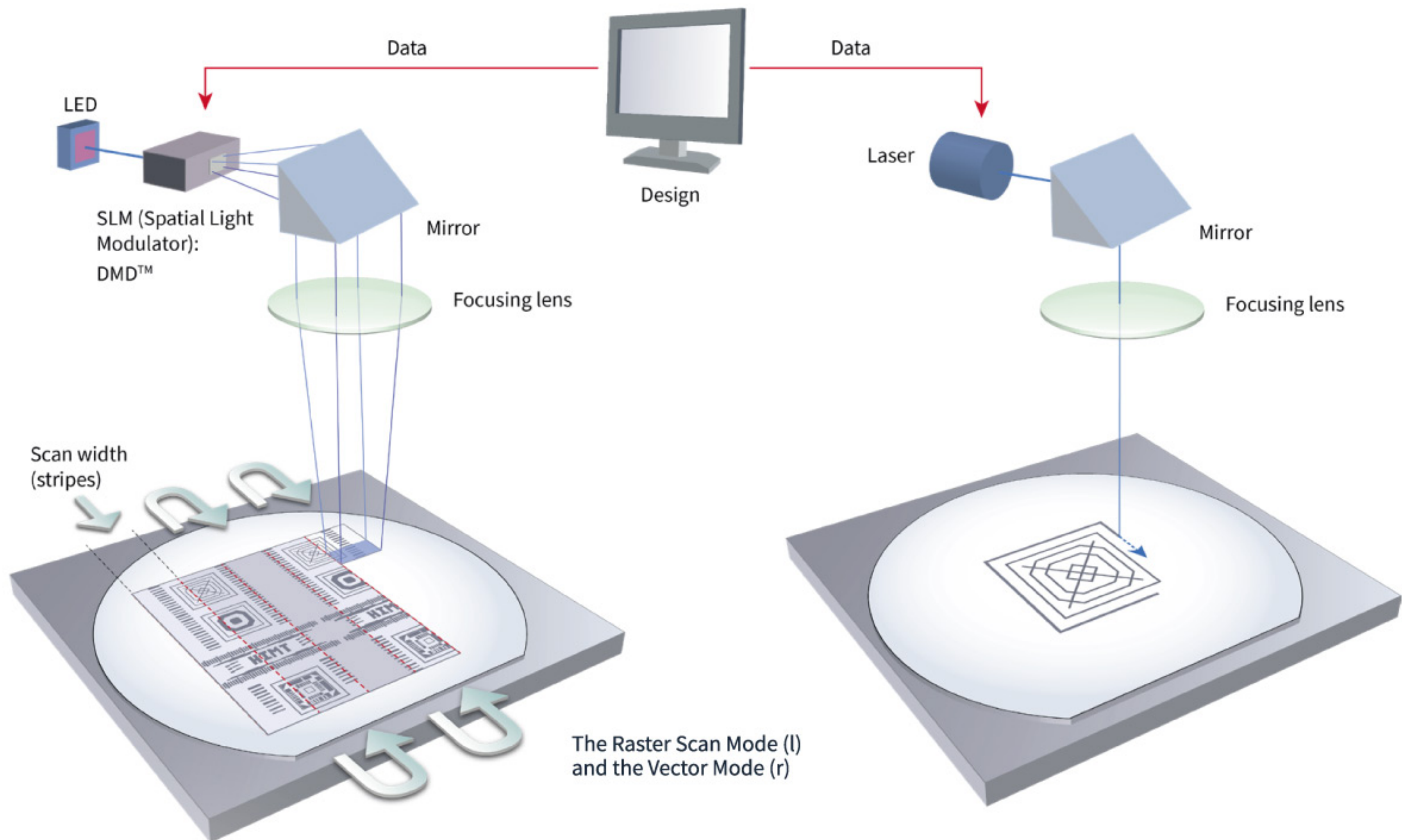
THE TABLETOP MASKLESS ALIGNER



μMLA

THE TABLETOP MASKLESS ALIGNER

The revolutionary, state-of-the-art maskless laser lithography technology has become firmly established ever since our Maskless Aligner (MLA) family was first introduced in 2015. The μMLA represents the state-of-the-art, highly customizable table-top Maskless Aligner. The set-up can be configured precisely to your needs, with Raster Scan Mode, Vector Scan Mode and variable resolution.



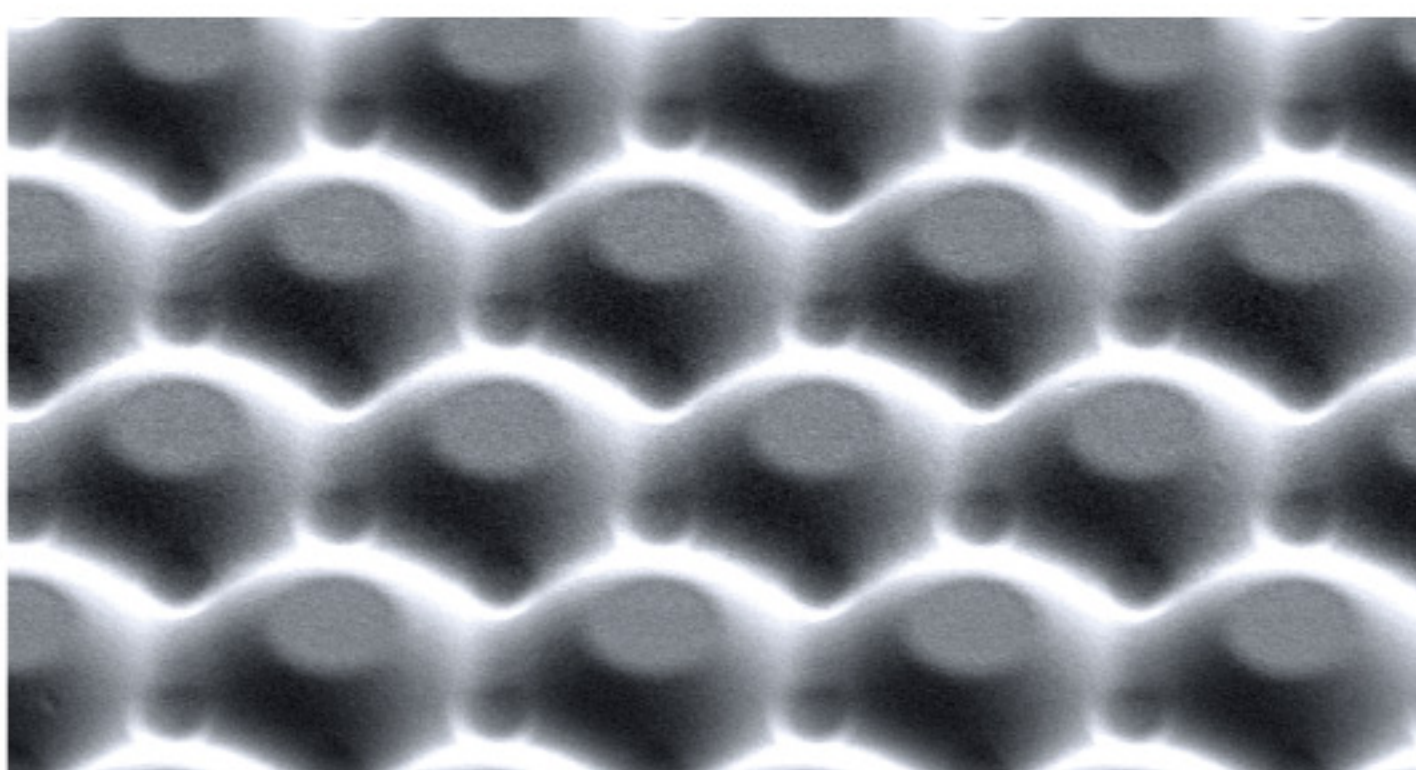
Small sample handling

In many applications, the traditional photomask has become a thing of the past. Maskless lithography means that your design file is exposed directly onto the resist-coated wafer via a 2-dimensional Spatial Light Modulator (SLM). The μMLA is the highly successful table-top system within our MLA family. It is „little brother“ to our Advanced Maskless Aligner MLA 150 – an indispensable workhorse in many multi-user facilities, nanofabrication labs, and national institutes – and our industrial Maskless Aligner, the

MLA 300. The entry-level system μMLA offers new features such as variable resolution. We created a table-top system that is flexible and highly customizable. And of course small sample handling is straightforward.

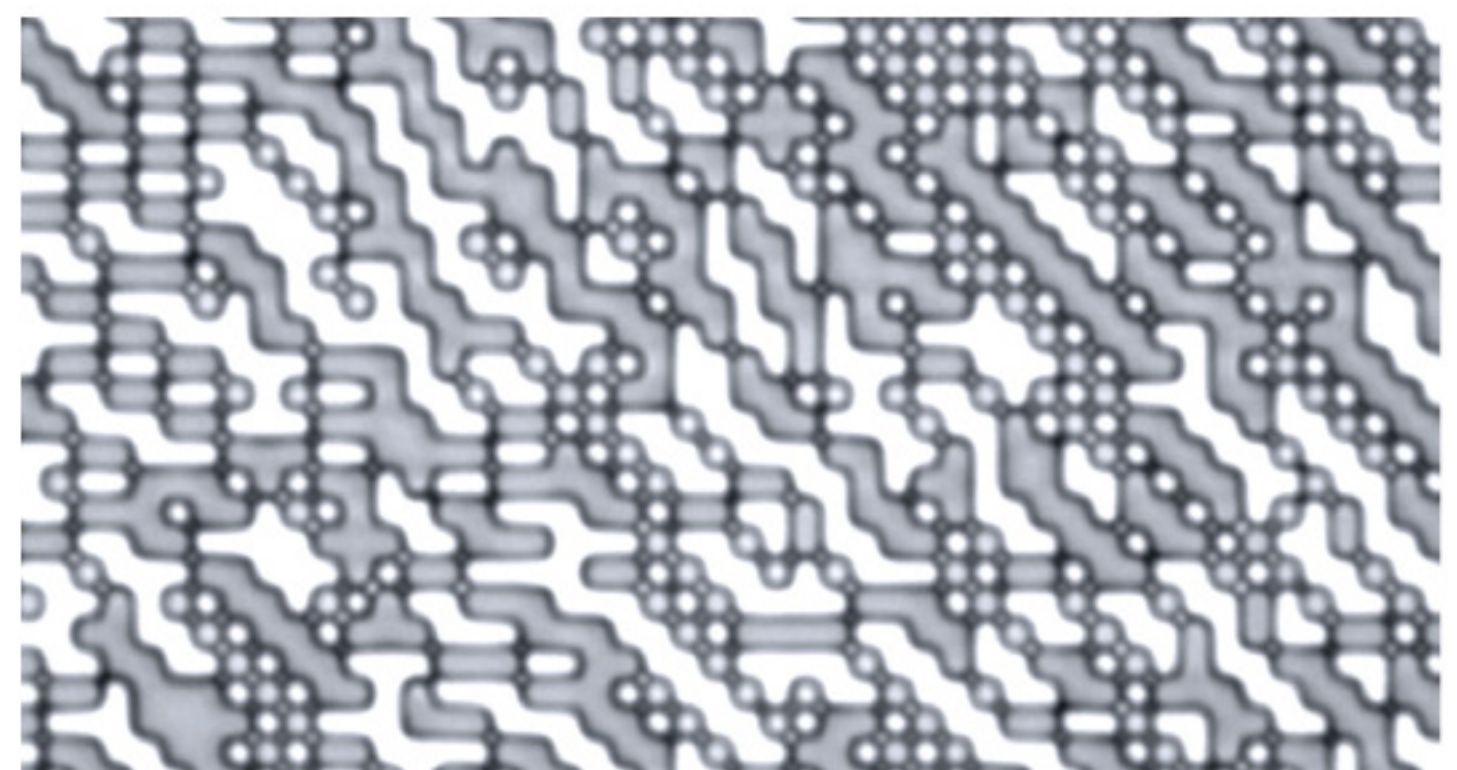
Applications include Research & Development in areas such as MEMS, micro-fluidics, micro-optics and all other fields where an affordable, compact, and powerful pattern generator for microstructures is required.

APPLICATIONS

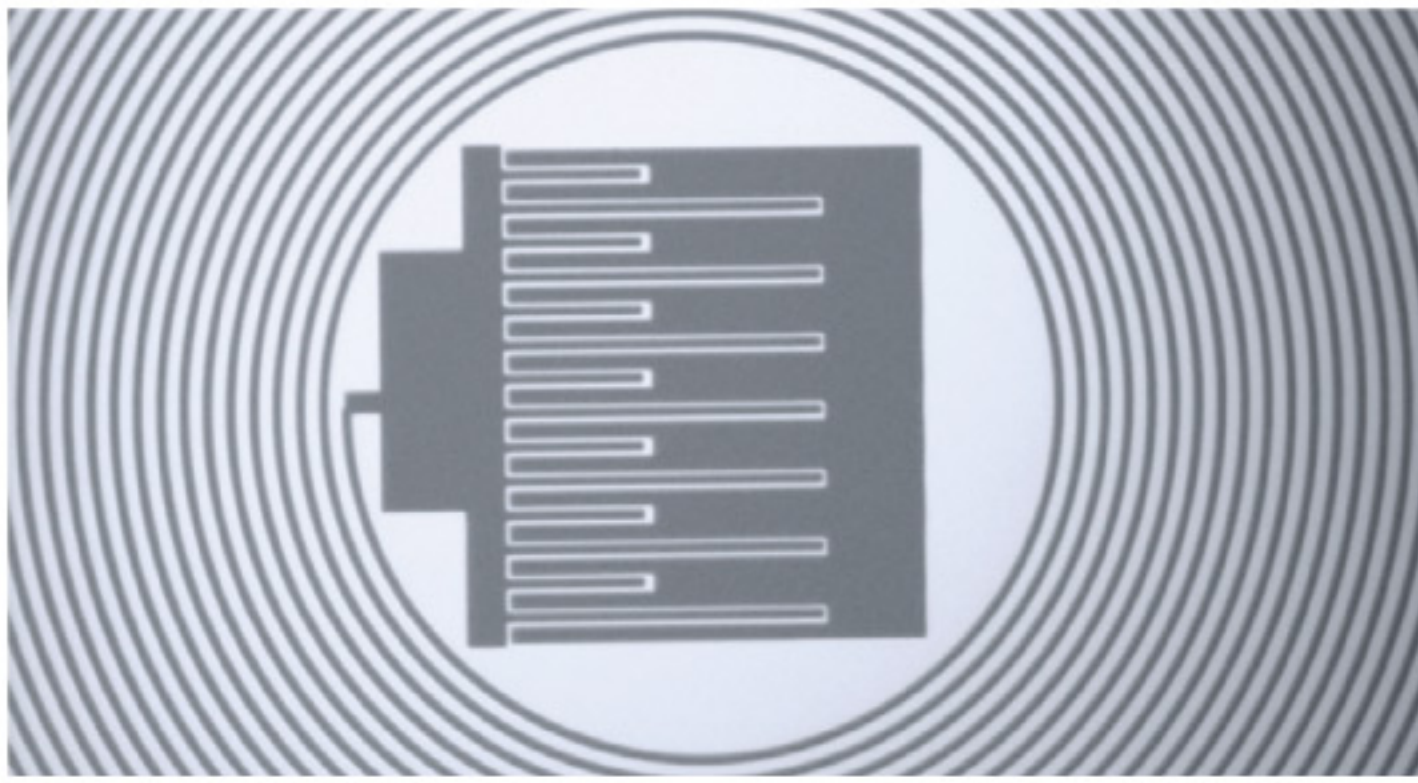


The μMLA offers a standard Grayscale mode, which allows the creation of micro-lenses. Resist: 15 μm thick AZ4562. Pitch 30 μm, radius of curvature 16 μm (l).

Micro-Optics: Binary diffractive optical element (DOE). The design is made up of 1 μm² squares (r).

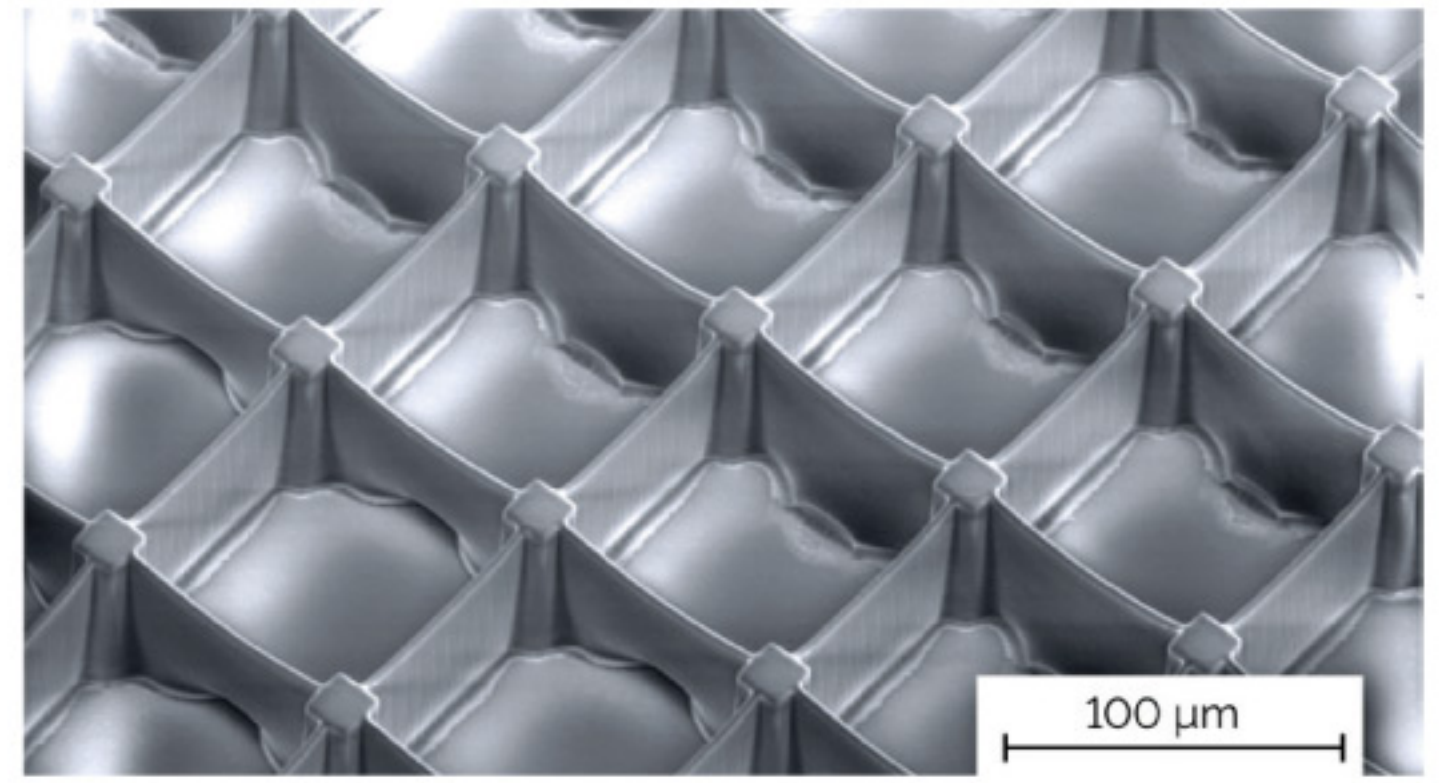


APPLICATIONS



Microfluidics (l).

Cage structures made of circa 50 μm thick SU-8. The structures are used in biological applications to trap and grow cells (r).



Courtesy of the University of Hamburg

CUSTOMIZE YOUR μMLA

Two Exposure Modes

The standard μMLA uses the Raster Scan Exposure Mode for exposures, which is fast and provides excellent image quality and fidelity, while the write time is independent of structure size or pattern density. The optional Vector Scan Mode can generate curved lines (e.g. waveguides) with minimal edge roughness. While Vector Mode creates similar image quality as the Raster Scan exposure mode, it cannot achieve the same write speed, especially for patterns with high fill factor.

The Surface at a Glance

The overview camera with a field of view of 13 mm x 10 mm provides an easy way to locate alignment marks or other features of interest on your substrate.

Small Sample Handling

Small sample handling is straightforward with the μMLA : The optical autofocus option allows accurate exposure right up to the edges of a sample.

A Choice of Wavelengths

You can use up to three different wavelengths (LED and/or laser diodes) on one system.

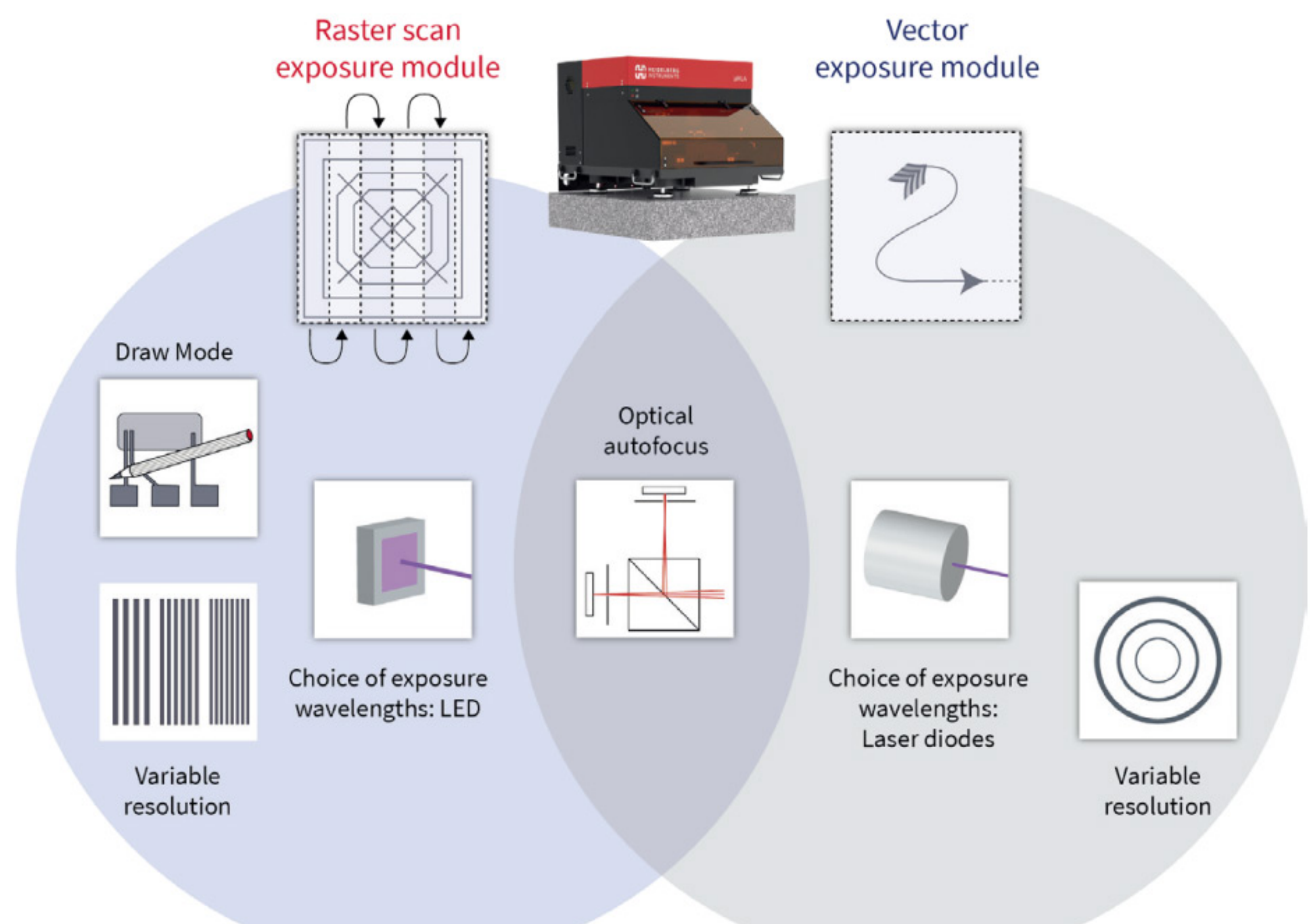
Variable Resolution

The variable resolution function allows you to choose up to three (raster mode) or five (vector mode) different resolutions for a particular write mode.

Simply select the resolution of choice in the software menu and optimize the parameters for your application.

Options offered by the Raster Scan Exposure Mode (blue circle) and by the Vector Exposure Mode (gray circle)

Overlap: Options available for both modes



μMLA

SYSTEM SPECIFICATIONS

| | Write Mode I* | Write Mode II* | Write Mode III* | |
|--|--|---|-------------------------------------|------------------|
| Writing performance (Raster Scan Exposure Module) | | | | |
| Minimum feature size [μm] | 0.6 | 1 | 3 | |
| Minimum lines and spaces [μm] | 0.8 | 1.5 | 3 | |
| Address grid [nm] | 20 | 50 | 100 | |
| Edge Roughness [3σ, nm] | 100 | 150 | 200 | |
| CD uniformity [3σ, nm] | 200 | 300 | 400 | |
| 2nd layer alignment over 5x5mm ² [nm] | 500 | 500 | 1000 | |
| 2nd layer alignment over 50x50mm ² [nm] | 1000 | 1000 | 2000 | |
| Writespeed | | | | |
| | with 390 nm LED / 365 nm LED | | with 390 nm LED | |
| Write speed | 10 mm ² /min at 0.6 μm | 40 mm ² /min at 1 μm | 130 mm ² /min at 3 μm | |
| Optional write speeds at different minimum structure sizes with "Variable Resolution for Raster Scan Exposure Module" | 18 mm ² /min at 1 μm | 60 mm ² /min at 2 μm | 160 mm ² /min at 4 μm | |
| | 25 mm ² /min at 2 μm | 90 mm ² /min at 4 μm | 300 mm ² /min at 6 μm | |
| Writing performance (Vector Mode Exposure Module) | | | | |
| Minimum feature Size [μm] | 0.6 | 1 | 3 | |
| Address grid [nm] | 20 | 20 | 20 | |
| 2nd layer alignment over 5 x 5 mm ² [nm] | 500 | 500 | 1000 | |
| 2nd layer alignment over 50 x 50 mm ² [nm] | 1000 | 1000 | 2000 | |
| Maximum linear write speed in Vector Mode | 200 mm/s | 200 mm/s | 200 mm/s | |
| Available spot sizes in Vector Mode [μm] | 0.6 / 1 / 2 / 5 / 10 | 1 / 2 / 5 / 10 / 25 | 3 / 5 / 10 / 25 / 50 | |
| System specifications | | | | |
| Maximum substrate size | 6" x 6" | | | |
| Minimum substrate size | 5 mm x 5 mm | | | |
| Substrate thickness | 0.1 to 12 mm | | | |
| Maximum write area | 150 mm x 150 mm | | | |
| Light source | Raster scan exposure module LED; 390 nm or 365 nm | Vector exposure module Laser; 405 nm and/or 375 nm | | |
| System dimensions (lithography unit) | | | | |
| | Width | Depth | Height | Weight |
| Main system housing | 640 mm (25") | 840 mm (33") | 530 mm (21") | 130 kg (285 lbs) |
| Installation requirements | | | | |
| Electrical | 230VAC/2.5A or 120VAC/4A or 100VAC/5A | | | |
| Compressed air | 6 - 10 bar | | | |
| Cleanroom | ISO 5 recommended | | | |
| Temperature stability | ±1°C | | | |

*Only one write mode can be installed on the system

Please note: Specifications and throughput depend on individual process conditions are equipment configuration. Design and specifications are subject to change without prior notice.

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